24V 2A 800kHz Synchronous Buck Converter With Adj. Soft Start

Features

- **Wide Input Voltage from 4.5V to 24V**
- **2A Continuous Output Current**
- **Adjustable Output Voltage from 0.807V to 13V**
- **Integrated Low $R_{DS(ON)}$ MOSFETs**
- **Fixed 800kHz Switching Frequency**
- **Stable with Low ESR Ceramic Output Capacitors**
- **Power-On-Reset Detection**
- **Over-Temperature Protection**
- **Current-Limit Protection with HICCUP Mode**
- **Programmable Soft-Start**
- **Small TSOT-23-8A Package**
- **Lead Free and Green Devices Available (RoHS Compliant)**

General Description

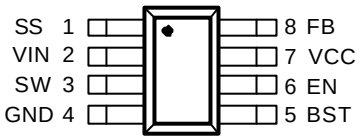
APW7510 is a 2A synchronous buck converter with integrated low $R_{DS(ON)}$ power MOSFETs. The APW7510 design with a current-mode control scheme, can convert wide input voltage of 4.5V to 24V to the output voltage adjustable from 0.807V to 13V to provide excellent output voltage regulation.

The APW7510 is equipped advance asynchronous modulation mode operation. Increase efficiency at light load. The APW7510 is also equipped with Power-on-reset, soft start, and whole protections (under-voltage, over-temperature, and current-limit) into a single package. This device, available TSOT-23-8A, provides a very compact system solution external components and PCB area.

Applications

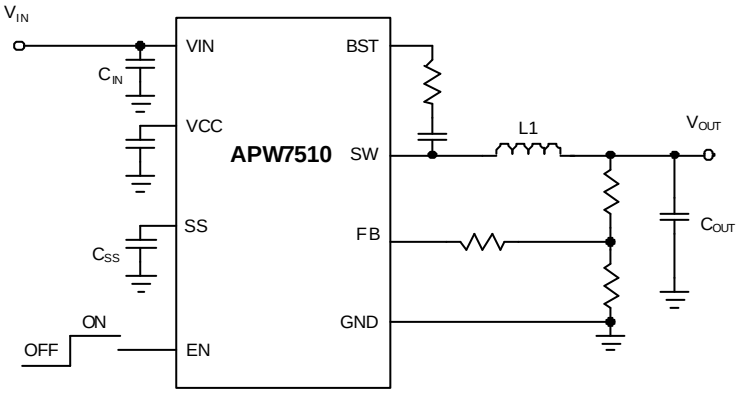
- **Notebook Systems and I/O Power**
- **Digital Set-Top Boxes**
- **Flat-Panel Television and Monitors**
- **Distributed Power Systems**

Pin Configuration



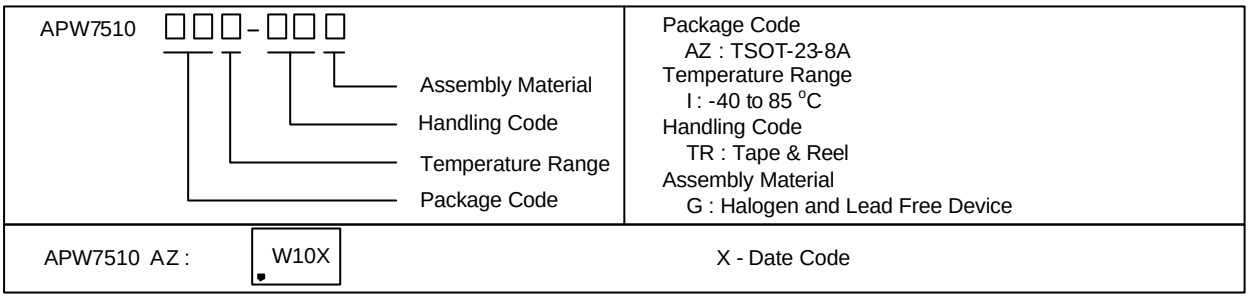
APW7510
TSOT-23-8A

Simplified Application Circuit



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Ordering and Marking Information



Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rating	Unit
V_{IN}, V_{EN}	VIN Supply to GND Voltage and EN to GND Voltage	-0.3 ~ 27	V
V_{SW}	SW to GND Voltage	-0.3 ~ 27	V
V_{BST-SW}	BST to SW Voltage	-0.3 ~ 6	V
	SS, VCC and FB to GND Voltage	-0.3 ~ 6	V
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature	-65 ~ 150	°C
T_{SDR}	Maximum Lead Soldering Temperature (10 Seconds)	260	°C

Note1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

Thermal Characteristics

Symbol	Parameter	Typical Value	Unit
θ_{JA}	Junction-to-Ambient Resistance in Free Air (Note 2)	100	°C/W

Note 2: θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air.

Recommended Operating Conditions (Note 3)

Symbol	Parameter	Range	Unit
V_{IN}	VIN Supply Voltage	4.5 ~ 24	V
V_{EN}	EN Input Voltage	0 ~ 24	V
V_{OUT}	Converter Output Voltage	0.807~13	V
I_{OUT}	Converter Output Current	0 ~ 2	A

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Recommended Operating Conditions (Cont.) (Note 3)

Symbol	Parameter	Range	Unit
C_{OUT}	Converter Output Capacitance	22 ~ 47	µF
L1	Inductance	1.5 ~ 10	µH
T_A	Ambient Temperature	-40 ~ 85	°C
T_J	Junction Temperature	-40 ~ 125	°C

Note 3 : Refer to the typical application circuit.

Electrical Characteristics

Unless otherwise specified, these specifications apply over V_{IN}=12V, V_{EN}=3V and T_A= -40 to 85 °C. Typical values are at T_A=25°C.

Symbol	Parameter	Test Conditions	APW7510			Unit
			Min	Typ	Max	
SUPPLY CURRENT						
I_{VIN}	VIN Supply Current	V_{FB}=0.9V, SW=NC	-	1	1.2	mA
I_{VIN_SD}	VIN Shutdown Supply Current	V_{EN}=0V	-	-	10	µA
POWER-ON-RESET (POR)						
	VIN POR Voltage Threshold	V_{IN} Rising	3.7	3.9	4.1	V
	VIN POR Hysteresis		-	0.6	-	V
REFERENCE VOLTAGE						
V_{REF}	Reference Voltage		-	0.807	-	V
	Output Voltage Accuracy	T_J=25°C, I_{OUT}=10mA	-1	-	+1	%
I_{FB}	FB input current		-	10	50	nA
V_{VCC}	VCC Regulator		-	5	-	V
	VCC Load Regulation	I_{VCC}=3mA	-	3	-	%
OSCILLATOR AND DUTY CYCLE						
F_{SW}	Switching Frequency		700	800	900	kHz
D_{AMX}	Maximum Duty Cycle		-	93	-	%
	Minimum on-time		-	-	100	ns
POWER MOSFET						
	High Side MOSFET Resistance		-	115	-	mΩ
	Low Side MOSFET Resistance		-	50	-	mΩ
	High Side Switch Leakage Current	V_{EN}=0V, V_{IN}=24V, V_{SW}=0V	-	-	1	µA
	Low Side Switch Leakage Current	V_{EN}=0V, V_{IN}=24V, V_{SW}=24V	-	-	1	µA
PROTECTIONS						
I_{LIM}	High Side MOSFET Current-Limit		3	4	5	A
	Under-Voltage Protection (UVP)		40	50	60	%V_{REF}
	FB Over Voltage Protection		120	125	130	%V_{REF}
	FB OVP Hysteresis		-	20	-	%V_{REF}
	Hiccup Delay time		-	1	-	T_{SS}
T_{OTR}	OTP Rising Threshold (Note 4)		-	150	-	°C
	OTP Hysteresis (Note 4)		-	30	-	°C

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Electrical Characteristics (cont.)

Unless otherwise specified, these specifications apply over V_{IN}=12V, V_{EN}=3V and T_A= -40 to 85 °C. Typical values are at T_A=25°C.

Symbol	Parameter	Test Conditions	APW7510			Unit
			Min	Typ	Max	
SOFT-START, ENABLE						
I_{SS}	Soft-Start Charge Current		-	11	-	µA
	EN Rising Threshold Voltage		1.2	1.4	1.6	V
	EN Falling Threshold Hysteresis		-	0.2	-	V
	EN turn off delay		-	8	-	µs
	EN Input Current	V_{EN}=2V	-	2	-	µA

Note4: Guaranteed by design.

Pin Description

PIN		FUNCTION
NO.	NAME	
1	SS	Soft Start. Connect a capacitor to GND to set the soft start interval.
2	VIN	Power Input. VIN supplies the power to the control circuitry, gate driver. Connecting a ceramic bypass capacitor and a suitably large capacitor between VIN and GND eliminates switching noise and voltage ripple on the input to the IC.
3	SW	Power Switching Output. SW is the Source of the N-Channel power MOSFET to supply power to the output LC filter.
4	GND	Signal and power ground.
5	BST	High-Side Gate Drive Boost Input. BS supplies the voltage to drive the high-side N-channel MOSFET. At least 10nF capacitor should be connected from SW to BST to supply the high side switch.
6	EN	Enable Input. EN is a digital input that turns the regulator on or off. EN threshold is 1.4V with 0.2V hysteresis.
7	VCC	Bias Supply. Decouple with a 0.1uF capacitor or higher is recommended.
8	FB	Output feedback Input. The IC senses the feedback voltage via FB and regulates FB voltage at 0.807V. Connecting FB with a resistor-divider from the converter's output to set the output voltage.

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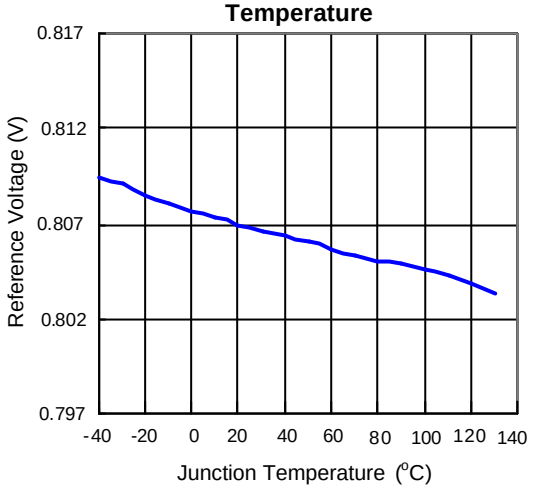
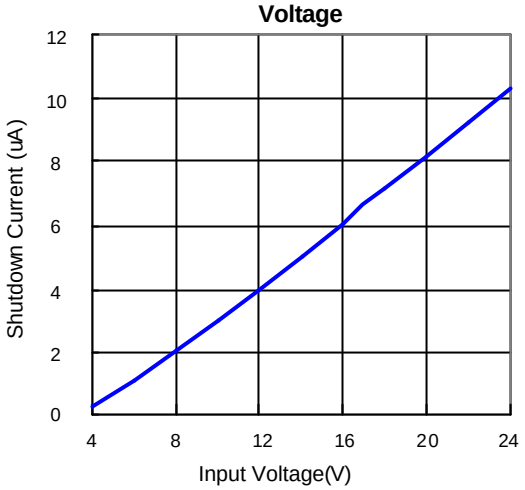
Typical Operating Characteristics

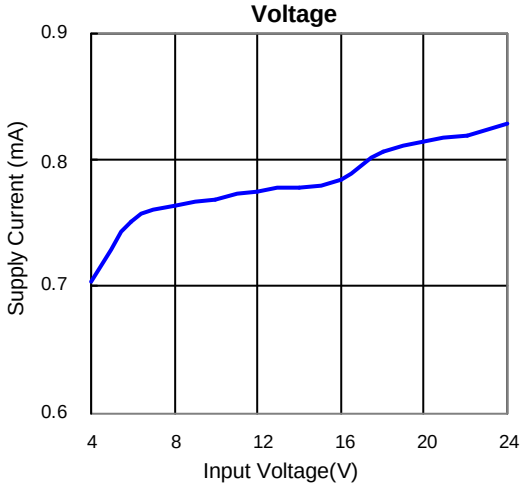
Reference Voltage vs. Junction Temperature



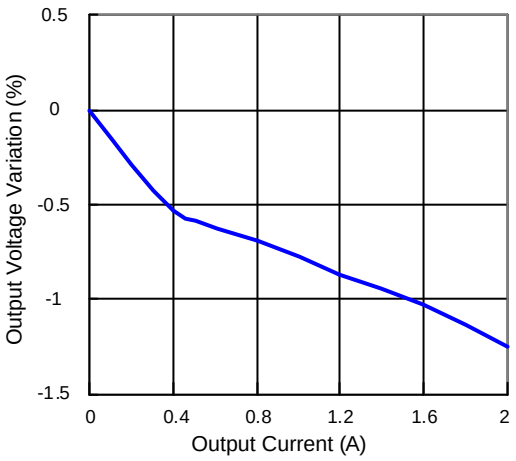
Shutdown Current vs. Input Voltage



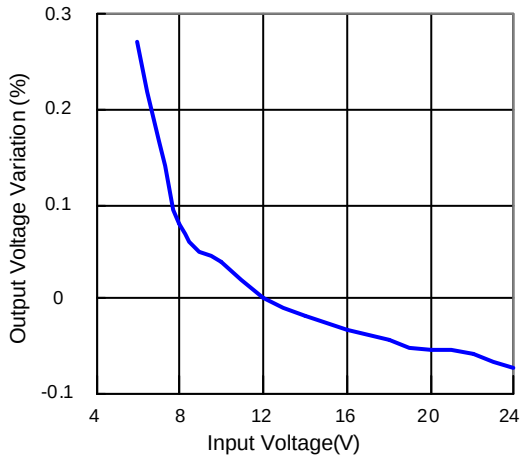
Supply Current vs. Input Voltage



Load Regulation



Line Regulation



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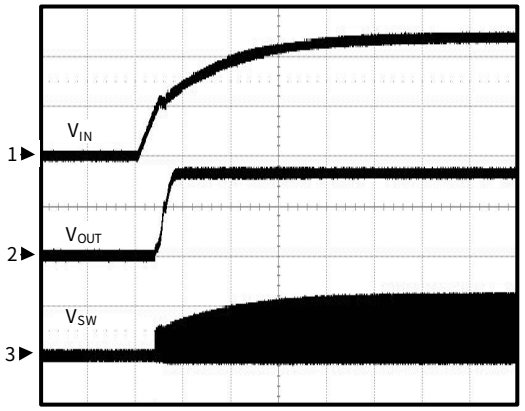
Operating Waveforms

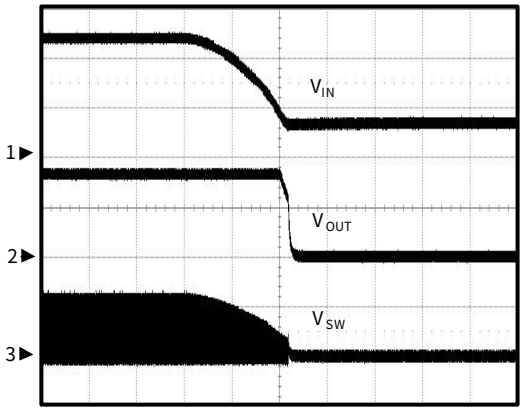
Refer to the typical application circuit. The test condition is V_{IN}=12V, T_A= 25°C unless otherwise specified.

Power On



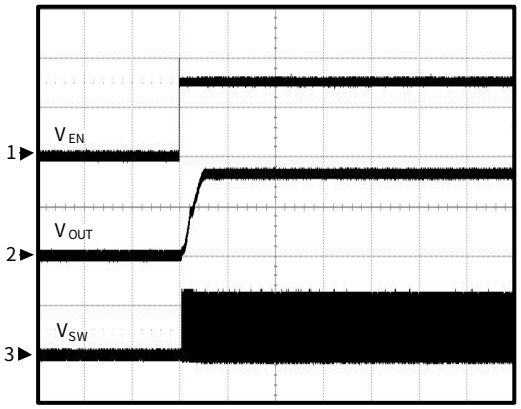
CH1: V_{IN}, 5V/Div
CH2: V_{OUT}, 2V/Div
CH3: V_{SW}, 10V/Div
TIME: 2ms/Div

Power Off



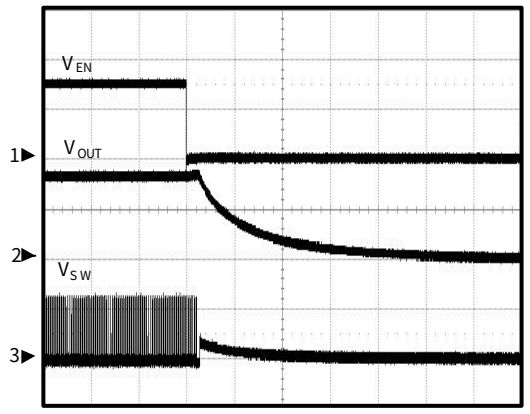
CH1: V_{IN}, 5V/Div
CH2: V_{OUT}, 2V/Div
CH3: V_{SW}, 10V/Div
TIME: 2ms/Div

Enable



CH1: V_{EN}, 2V/Div
CH2: V_{OUT}, 2V/Div
CH3: V_{SW}, 10V/Div
TIME: 2ms/Div

Shutdown



CH1: V_{EN}, 2V/Div
CH2: V_{OUT}, 2V/Div
CH3: V_{SW}, 10V/Div
TIME: 50us/Div

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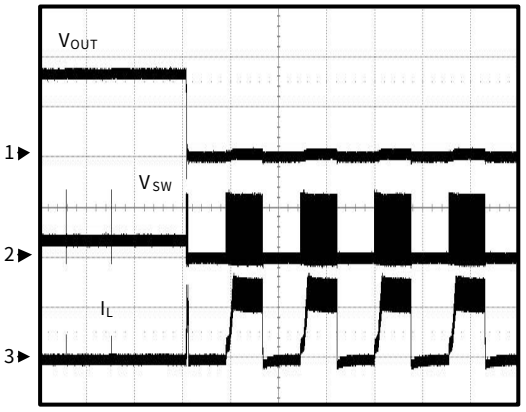
Operating Waveforms

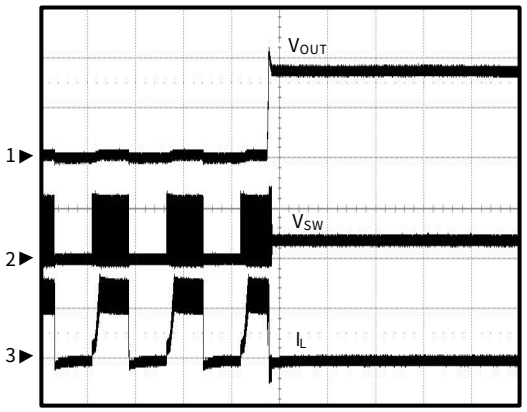
Refer to the typical application circuit. The test condition is V_{IN}=12V, T_A= 25°C unless otherwise specified.

Short-Current Entry



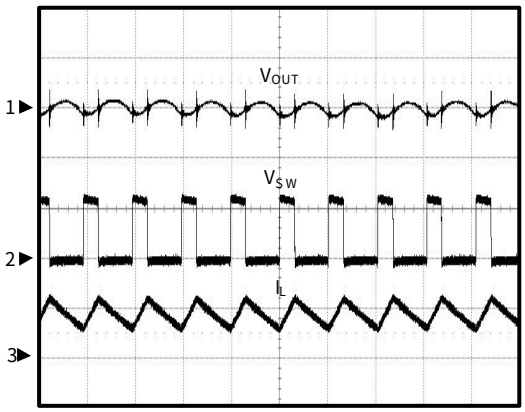
CH1: V_{OUT}, 2V/Div
CH2: V_{SW},10V/Div
CH3: I_L,2A/Div
TIME: 2ms/Div

Short-Current Recovery



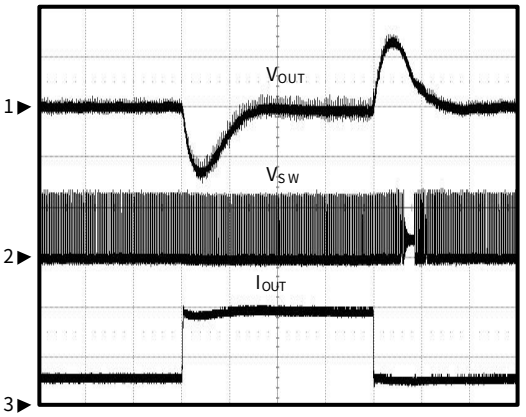
CH1: V_{OUT}, 2V/Div
CH2: V_{SW},10V/Div
CH3: I_L,2A/Div
TIME: 2ms/Div

Vout Ripple



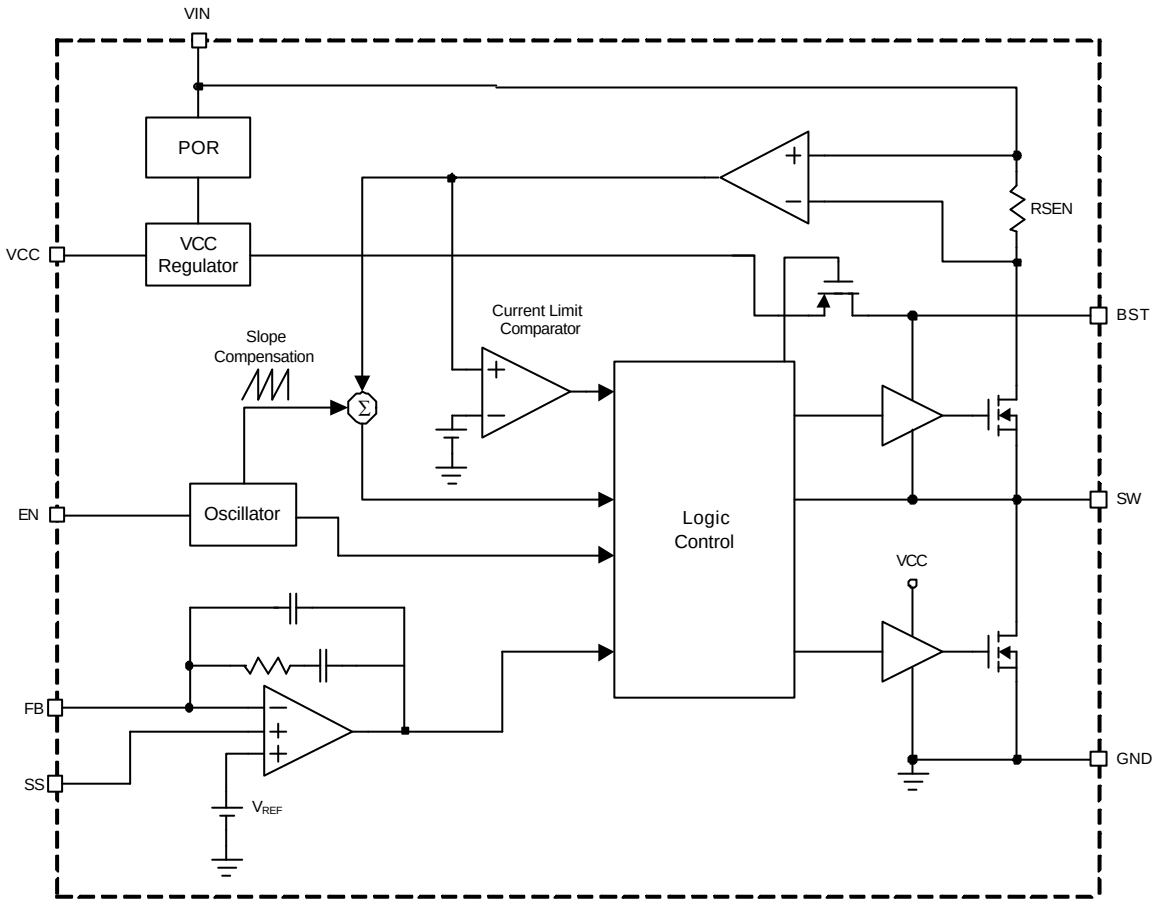
CH1: V_{OUT}, 50mV/Div,AC
CH2: V_{SWX},10V/Div
CH3: I_L,2A/Div
TIME: 2us/Div

Load Transient



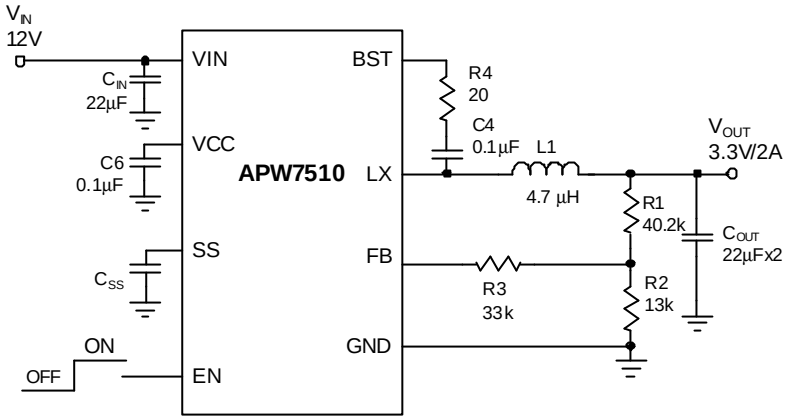
CH1: V_{OUT}, 100mV/DIV,AC
CH2: V_{SW} ,10V/Div
CH3: I_{OUT},1A/Div
TIME: 50us/Div

Block Diagram



Typical Application Circuit

Dual Power Input : VIN Pre-existing & VOUT setting less than VIN POR



Single Power Input : VIN divided to EN & VOUT setting more than VIN POR

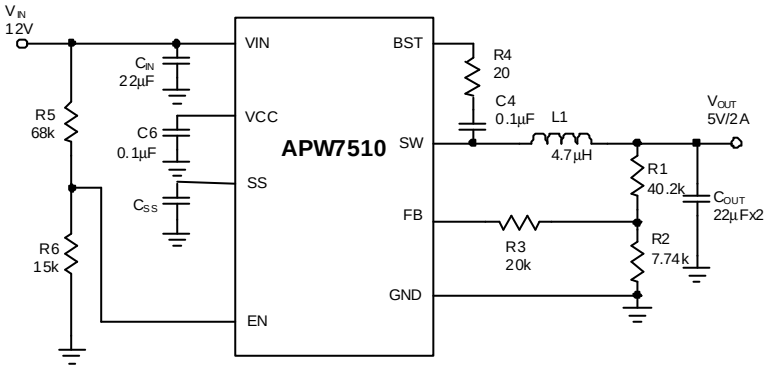


Table 1. Componments Selection for Different Output Voltage

V_{OUT} (V)	R1 (kW)	R2 (kW)	R3 (kW)	R4 (W)	L (uH)	C_{OUT} (uF)
1.05	20.5	68.1	100	20~60	1.5	44
1.2	20.5	42.1	75	20~60	1.8	44
3.3	40.2	13	33	20~60	4.7	44
5	40.2	7.74	20	20~60	4.7	44

Function Description

Main Control Loop

The APW7510 is a constant frequency, synchronous rectifier and current-mode switching regulator. In normal operation, the internal upper power MOSFET is turned on each cycle. The peak inductor current at which ICMP turn off the upper MOSFET is controlled by the voltage on the COMP node, which is the output of the error amplifier (EAMP). An external resistive divider connected between VOUT and ground allows the EAMP to receive an output feedback voltage V_{FB} at FB pin. When the load current increases, it causes a slightly decrease in V_{FB} relative to the 0.807V reference, which in turn causes the COMP voltage to increase until the average inductor current matches the new load current.

Enable/Shutdown

Driving EN to the ground places the APW7510 in shutdown mode. When in shutdown, the internal power MOSFETs turn off, all internal circuitry shuts down and the quiescent supply current reduces to 1μA typical.

Under Voltage Lockout (UVLO)

An under-voltage lockout function prevents the device from operating if the input voltage on VIN is lower than approximately 3.9V. The device automatically enters the shutdown mode if the voltage on VIN drops below approximately 3.9V. This under-voltage lockout function is implemented in order to prevent the malfunctioning of the converter.

Over-Current-Protection and Hiccup

The APW7510 has a cycle-by-cycle over-current limit when the inductor current peak value exceeds the set current limit threshold. Meanwhile, the output voltage drops until FB is below the Under-Voltage (UV) threshold below the reference. Once UV is triggered, the APW7510 enters hiccup mode to periodically restart the part. This protection mode is especially useful when the output is dead-shorted to ground. The average short circuit current is greatly reduced to alleviate thermal issues and to protect the regulator. The APW7510 exits the hiccup mode once the over-current condition is removed.

Over-Temperature Protection (OTP)

The over-temperature circuit limits the junction temperature of the APW7510. When the junction temperature exceeds 150°C, a thermal sensor turns off the both power MOSFETs, allowing the devices to cool. The thermal sensor allows the converters to start a soft-start process and regulate the output voltage again after the junction temperature cools by 30°C. The OTP is designed with a 30°C hysteresis to lower the average Junction Temperature (T_J) during continuous thermal overload conditions, increasing the lifetime of the device.

Over-Voltage Protection (OVP)

The over-voltage function monitors the output voltage by FB pin. Once the FB voltage exceeds 125% of the reference voltage, the over-voltage protection comparator forces the low-side MOSFET on. This action actively pulls down the output voltage to prevent the end device be damage. As soon as the output voltage is below 105% of the reference voltage, the low-side MOSFET off and the OVP comparator is disengaged. The chip restores its normal operation.

Frequency Foldback

The foldback frequency is controlled by the FB voltage. When the output is short to the ground, the frequency of the oscillator will be reduced to 0.25 x F_{SW}. This lower frequency allows the inductor current to safely discharge, there by preventing current runaway. The oscillator's frequency will gradually increase to its designed rate when the feedback voltgae on FB again approaches 0.807V.

Soft-Start

The APW7510 provides the programmed soft-start function to limit the inrush current. The soft-start time can be programmed by the external capacitor between SS and GND. Typical charge current is 11μA, and the soft-start time can be calculated by the following formula:

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Function Description

Soft-Start (cont.)

$$T_{SS}(ms) = \frac{C_{SS}(nF) \times 0.807(V)}{11(\mu A)}$$

The APW7510 integrates soft-start circuits to ramp up the output voltage of the converter to the programmed regulation set point at a predictable slew rate. The slew rate of output voltage is internally controlled to limit the inrush current through the output capacitors during soft start process. When the EN pin is pulled above the rising EN threshold voltage, the device initiates a soft-start process to ramp up the output voltage.

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Application Information

Input Capacitor Selection

Because buck converters have a pulsating input current, a low ESR input capacitor is required. This results in the best input voltage filtering, minimizing the interference with other circuits caused by high input voltage spikes. Also, the input capacitor must be sufficiently large to stabilize the input voltage during heavy load transients. For good input voltage filtering, usually a 22µF input capacitor is sufficient. It can be increased without any limit for better input-voltage filtering. Ceramic capacitors show better performance because of the low ESR value, and they are less sensitive against voltage transients and spikes compared to tantalum capacitors. Place the input capacitor as close as possible to the input and GND pin of the device for better performance.

Inductor Selection

For high efficiencies, the inductor should have a low DC resistance to minimize conduction losses. Especially at high-switching frequencies, the core material has a higher impact on efficiency. When using small chip inductors, the efficiency is reduced mainly due to higher inductor core losses. This needs to be considered when selecting the appropriate inductor. The inductor value determines the inductor ripple current. The larger the inductor value, the smaller the inductor ripple current and the lower the conduction losses of the converter. Conversely, larger inductor values cause a slower load transient response. A reasonable starting point for setting ripple current, ΔI_L, is 40% of maximum output current. The recommended inductor value can be calculated as below:

$$L \geq \frac{V_{OUT}\left(1-\frac{V_{OUT}}{V_{IN}}\right)}{F_{SW}\cdot \Delta I_L}$$

$$I_{L(MAX)} = I_{OUT(MAX)} + \frac{1}{2}\Delta I_L$$

To avoid saturation of the inductor, the inductor should be rated at least for the maximum output current of the converter plus the inductor ripple current.

Output Voltage Setting

In the adjustable version, the output voltage is set by a resistive divider. The external resistive divider is connected to the output, allowing remote voltage sensing as shown in "Typical Application Circuits". The output voltage can be calculated as below:

$$V_{OUT} = V_{REF}\cdot\left(1+\frac{R1}{R2}\right) = 0.807\cdot\left(1+\frac{R1}{R2}\right)$$

If VOUT setting less than VIN POR, suggest using Dual Power Input of Typical Application Circuit.
If VOUT setting more than VIN POR, suggest using Single Power Input of Typical Application Circuit.

Output Capacitor Selection

The current-mode control scheme of the APW7510 allows the use of tiny ceramic capacitors. The higher capacitor value provides the good load transients response. Ceramic capacitors with low ESR values have the lowest output voltage ripple and are recommended. If required, tantalum capacitors may be used as well. The output ripple is the sum of the voltages across the ESR and the ideal output capacitor.

$$\Delta V_{OUT} \cong \frac{V_{OUT}\cdot\left(1-\frac{V_{OUT}}{V_{IN}}\right)}{F_{SW}\cdot L}\cdot\left(ESR+\frac{1}{8\cdot F_{SW}\cdot C_{OUT}}\right)$$

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

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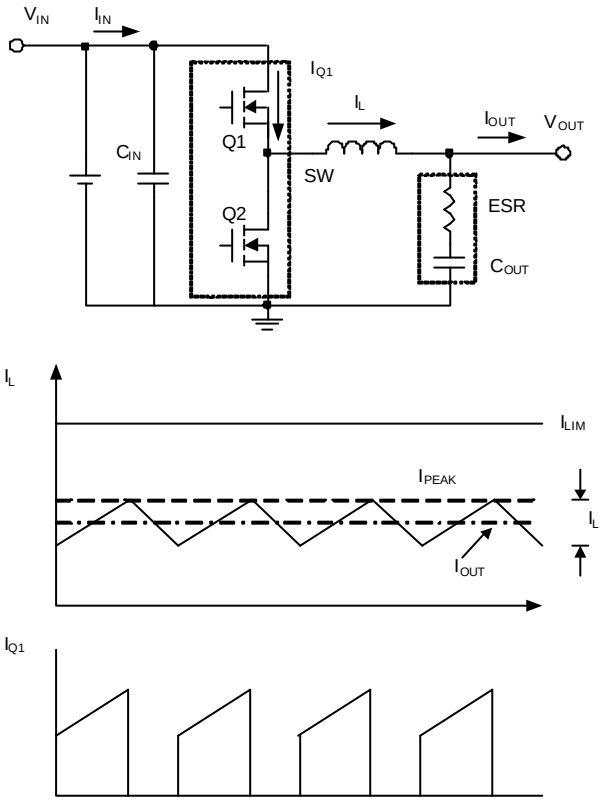
Application Information

Output Capacitor Selection

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

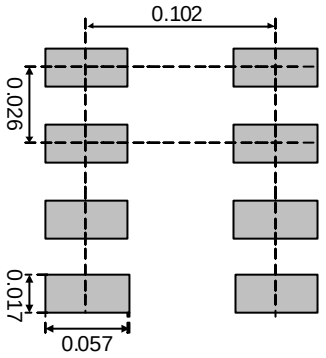


Layout Consideration

For all switching power supplies, the layout is an important step in the design; especially at high peak currents and switching frequencies. If the layout is not carefully done, the regulator might show noise problems and duty cycle jitter.

1. The input capacitor should be placed close to the VIN and GND. Connecting the capacitor and VIN/GND with short and wide trace without any via holes for good input voltage filtering. The distance between VIN/GND to capacitor less than 2mm respectively is recommended.
2. To minimize copper trace connections that can inject noise into the system, the inductor should be placed as close as possible to the SW pin to minimize the noise coupling into other circuits.
3. The output capacitor should be place closed to converter VOUT and GND.
4. Since the feedback pin and network is a high impedance circuit the feedback network should be routed away from the inductor. The feedback pin and feedback network should be shielded with a ground plane or trace to minimize noise coupling into this circuit.
5. A star ground connection or ground plane minimizes ground shifts and noise is recommended.

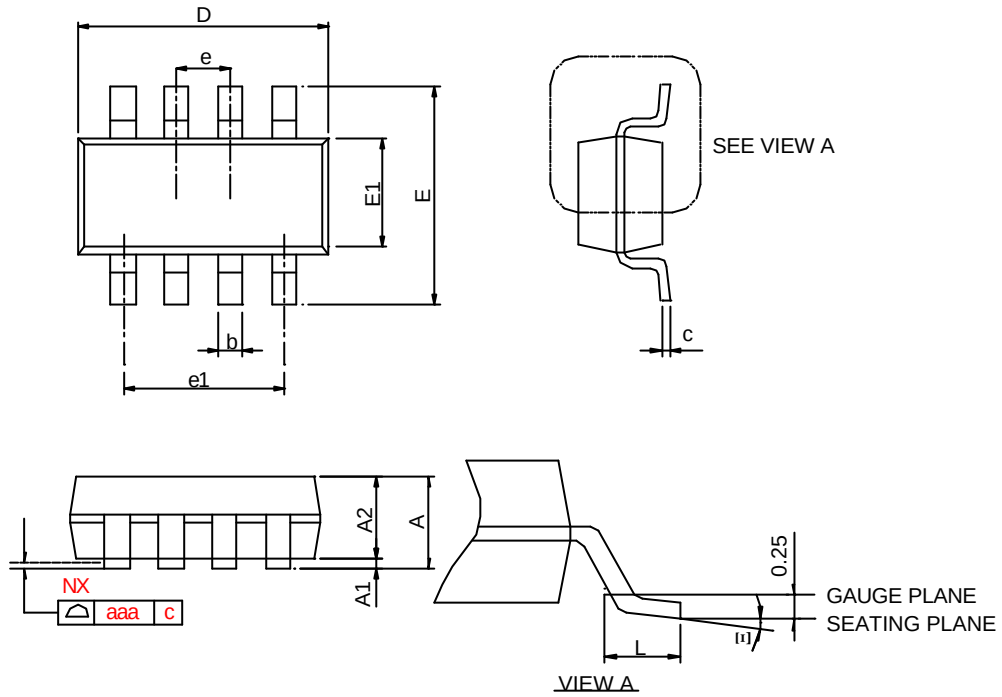
Recommended Minimum Footprint



TSOT-23-8A

Package Information

TSOT-23-8A



SYMBOL	TSOT-23-8A			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.70	1.00	0.028	0.039
A1	0.01	0.10	0.000	0.004
A2	0.70	0.90	0.028	0.035
b	0.22	0.40	0.009	0.016
c	0.08	0.20	0.003	0.008
D	2.70	310	0.106	0.122
E	2.60	3.00	0.102	0.118
E1	1.40	1.80	0.055	0.071
e	0.65 BSC		0.026 BSC	
e1	1.95 BSC		0.077 BSC	
L	0.30	0.60	0.012	0.024
θ	0^o	8^o	0^o	8^o
aaa	0.10		0.004	

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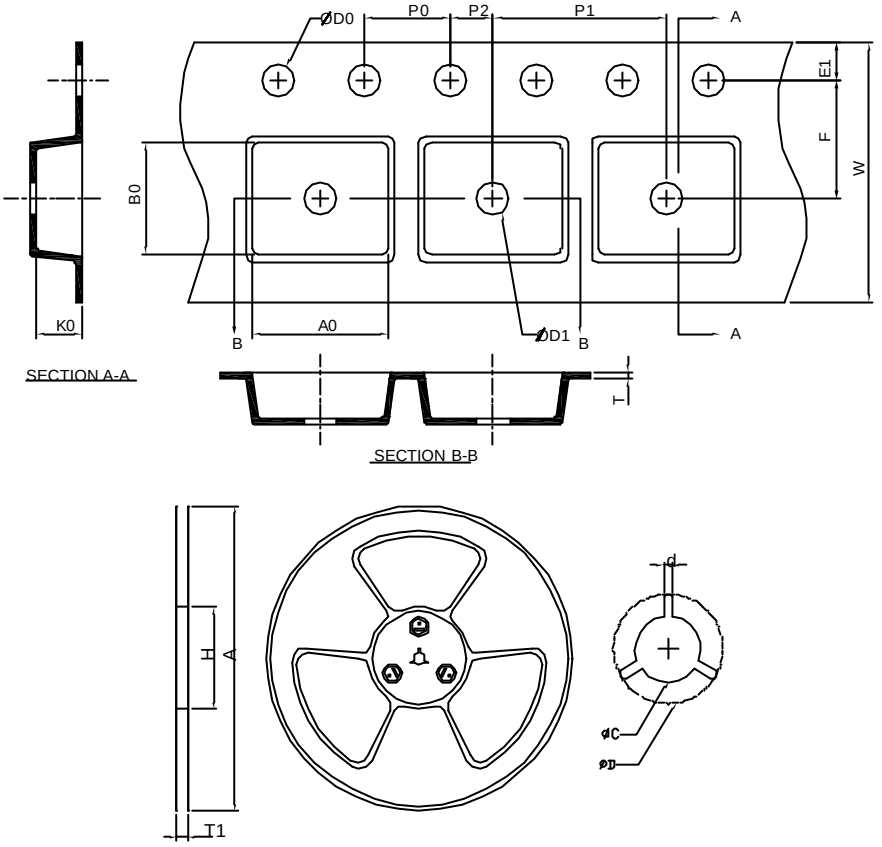
Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
TSOT-23-8A	178.0±2.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0±0.30	1.75±0.10	3.5±0.05
	P0	**P1**	**P2**	**D0**	**D1**	**T**	**A0**	**B0**	**K0**
	4.0±0.10	4.0±0.10	2.0±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20±0.20	3.10±0.20	1.20±0.20

(mm)

Devices Per Unit

Package Type	Unit	Quantity
TSOT-23-8A	Tape & Reel	3000

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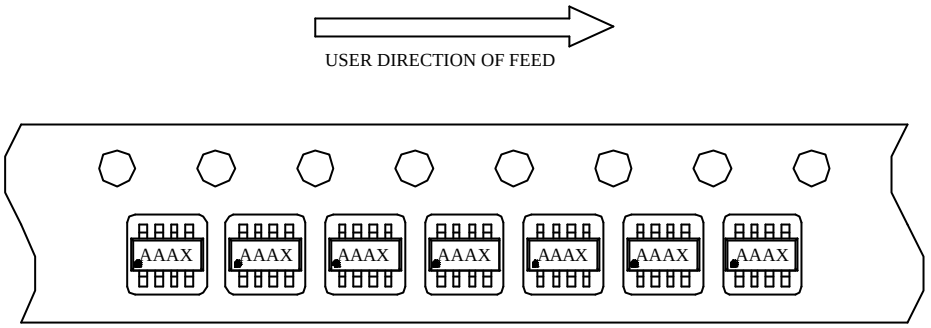
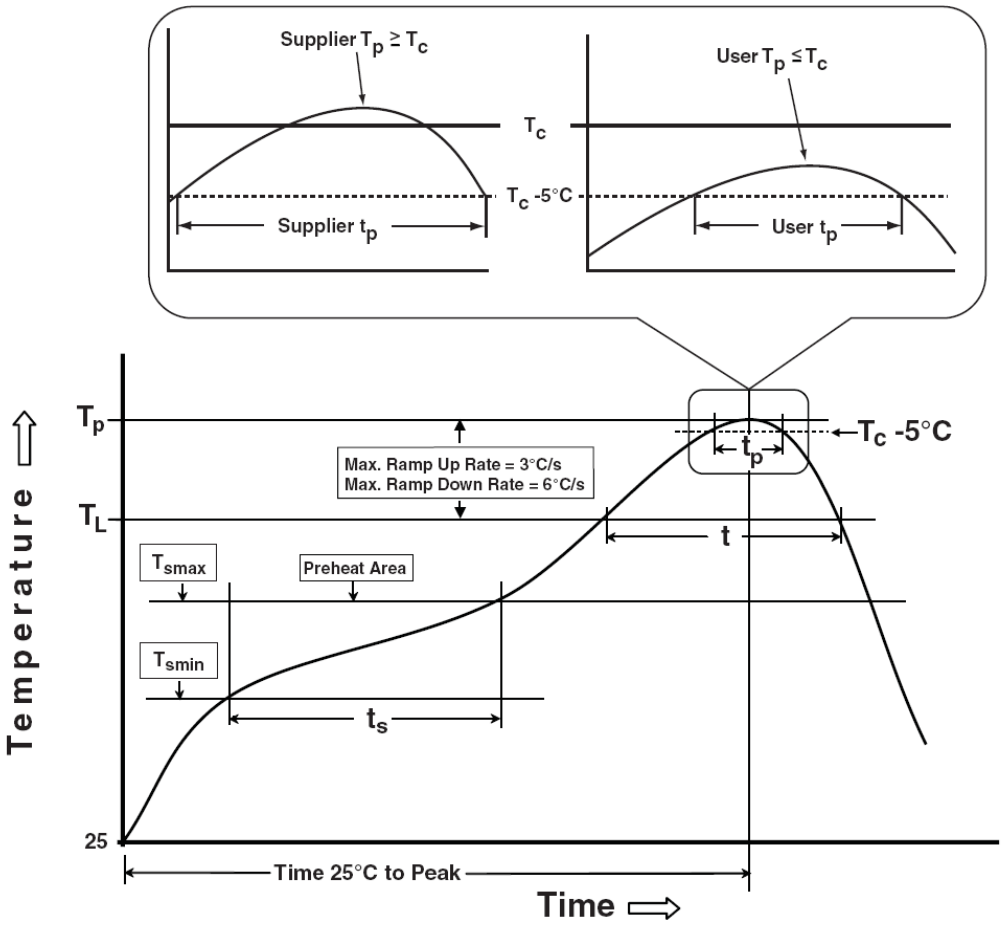
Taping Direction Information

TSOT-23-8A



Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (T_{smax} to T_P)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L) Time at liquidous (t_L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_P)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm^3 <350	Volume mm^3 350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm^3 <350	Volume mm^3 350-2000	Volume mm^3 >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	1000 Hrs, Bias @ Tj=125°C
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C
HBM	MIL-STD-883-3015.7	VHBM≧2KV
MM	JESD-22, A115	VMM≧200V
Latch-Up	JESD 78	10ms, 1_{tr}≧100mA

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Customer Service

Anpec Electronics Corp.
Head Office :
No.6, Dusing 1st Road, SBIP,
Hsin-Chu, Taiwan, R.O.C.
Tel : 886-3-5642000
Fax : 886-3-5642050

Taipei Branch :
2F, No. 11, Lane 218, Sec 2 Jhongsing Rd.,
Sindian City, Taipei County 23146, Taiwan
Tel : 886-2-2910-3838
Fax : 886-2-2917-3838